

95264-3XX(H)LF 0.75µm Au MIN. OVER 1.3µm Ni MIN. Sn OVER Ni PLATING CODE CONTACT AREA Solution Solution PLATING CODE CONTACT AREA Solution Solution	5,µm Sn	95264-6XX(H)LF 2µm Au MIN. OVER 1.3µm Ni MIN. 95264-8XX(H)LF 0.4µm Au MIN. OVER 1.3µm Ni MIN	-				95264-Y09(H)LF 2x14 33.02 35.48 X <th></th> <th>2x4 7.62 10.08 x x 2x5 10.16 12.62 X X x x x x x</th> <th>95264-Y03(H)LF 2x11 35.56 38.02 $\land \land \land$</th> <th>< × × × < × × × < × × × < × × × < × × × × × × × × × × × × × × ×</th> <th>NB of POS. DIM"C" DIM"D" CONTACT PLACED IN CAVITY (SEI NB of POS. DIM"C" 1 2 3 4 5 6 7 8 9 10 11 X<!--</th--></th>		2x4 7.62 10.08 x x 2x5 10.16 12.62 X X x x x x x	95264-Y03(H)LF 2x11 35.56 38.02 $\land \land \land$	< × × × < × × × < × × × < × × × < × × × × × × × × × × × × × × ×	NB of POS. DIM"C" DIM"D" CONTACT PLACED IN CAVITY (SEI NB of POS. DIM"C" 1 2 3 4 5 6 7 8 9 10 11 X </th
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e CUSTOMER Drawing	SPREADED .300 SELECT.	product family							2.9 ±0.3			